

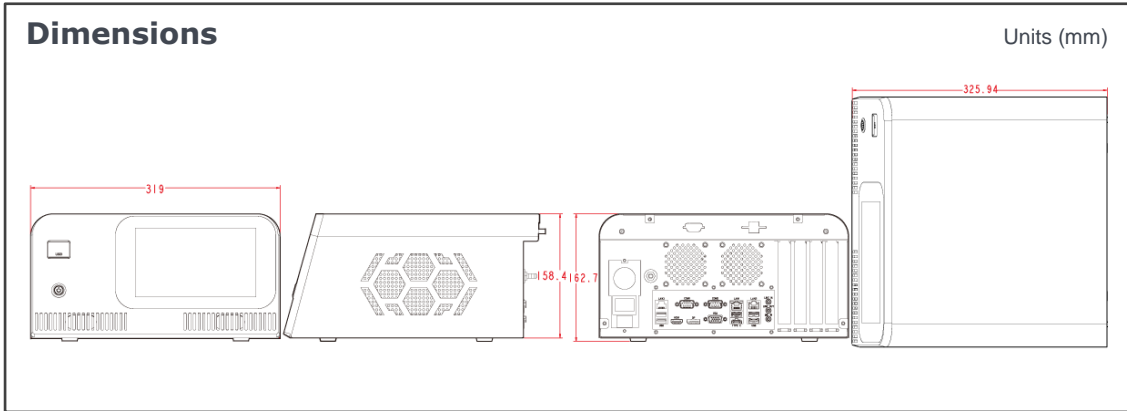


Features

- Intel® 12th Gen. (Alder lake S) Core™ Processor w/ W680 chipset
- 4 x 288-pin ECC/non-ECC Long-DIMM DDR4 3200 MHz, up to 128GB (32GB per DIMM)
- 2 x M.2 M.Key PCIe4 Gen 4 SSD (Support NVMe SSD), 1 x SATA3 SSD
- 1 X PCIe16 (Gen4), 1 x PCIe8 (Gen4), 1 x PCIe4 (Gen4)
- 3 x Display Out, HDMI & DP & VGA
- 1 x USB Type C, 5 x USB 3.2 Gen2, 1 X USB 3.2 Gen1, 2 x COM, 3 X lan (2.5Gb)
- TPM 2.0 On Board

Specification

| Product | | WPC-789-PSI |
|----------------------------|--|--|
| Main System | CPU / Chipset | Intel® 12 th Generation Intel® Core i9/i7/i5 Processor, 65W Max. Intel® W680 Express Chipset |
| | Graphic | Intel® UHD Graphics 770 |
| | RAM | Four 3200 MHz DDR4 Long-DIMM socket support dual Channel, ECC/non-ECC, up to 128GB |
| | TPM | TPM 2.0 On Board |
| | OS Support | Windows 10 (2021-LTSC) (64bit), Windows 11 (64bit) |
| I/O Ports | USB | Front: 2 x USB 3.2 Gen1 (W/Cover) Rear: 5 x USB 3.2 Gen2, 1 x USB 3.2 Gen2 (20G) Type C |
| | COM | 2 x RS232/RS422/RS485 |
| | Video output | 1 x DP1.4a, 1 x HDMI 2.0, 1 x VGA |
| | Audio | 3.5mm phone jack (Line-in, Line-out, Mic-in) |
| | LAN | 3 x RJ-45 (Intel® 1225LM supports AMT/Vpro) |
| | Power Switch | Power On / Off, Remote Power button (Phoenix 4 Pin connector or DB 9 Female) |
| Storage & Expansion | Storage | 1 x M.2 (Key M, up to 25110) w/PCIe4 Gen4 for SSD up to 1TB; 1 x M.2 (Key M, 2242/2260/2280) w/PCIe4 Gen3 for SSD up to 1TB; 1 x 2.5" 7mm SATA3 SSD, up to 2TB |
| | Expansion slot | 1 x M.2 (Key E, 2230) for Wireless, 1 x M.2 (Key B, 3042/3052), 1 x SIM socket connect to M.2 Key B 2 x PCIe Gen4 Slots (PCIe1/PCIe3: single at x16(PCIe1), dual at x8 (PCIe1) / x8 (PCIe3)) / (PCIe1: Support riser card x8/x8) PCIe4 (Gen4)* x 2 |
| Power | Power input | ATX PWR (24+8-pin) |
| | Power adapter | AC input 100 ~240V / 47 ~ 63 Hz / 500W |
| | Power consumption | TBD |
| Environmental | Temperature | Operating Temperature 0~40°C Storage Temperature -20~60°C |
| | Humidity | Operating & Storage: 20 ~ 90%, non-condensing |
| | Shock/Vibration /Drop | Shock Operation 15g/ 0.53 oz, 11 ms, half sine wave Vibration Operation 5 ~ 17 Hz, Amplitude : 0.2" 17 ~ 500Hz, Acceleration : 1.0G Drop Operation Free fall: 3 feets, 1 corner, 3 edges, 6 faces |
| | Cooling | Smart Fan, Noise less than 30dB at 25°C (ambient temp.) |
| Mechanical Characteristics | Housing | SECC with hospital white painting |
| | Dimensions | 319 x 326 x 163 (mm) |
| | Weights | TBD |
| Certification | CE: EN 60601-1-2 (V4.1), EN 60601-1 (V3.2) VCCI: 2016-11, Class B (PSU with PSE) FCC: Part 18 Class B UL: ANSI/AAMI ES60601-1:2012 (V3.2) cUL: CAN/CSA-C22.2 No. 60601-1:2014 (V3.2) ISO 14971 / IEC62133 | |

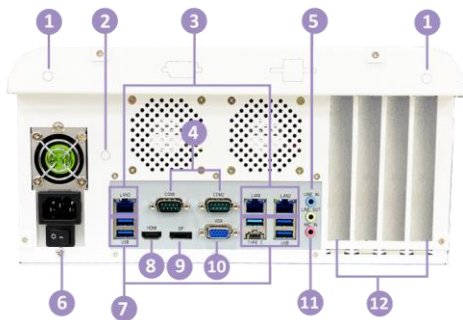


| Major Options | |
|----------------|--|
| Options | <ol style="list-style-type: none"> 1. Wifi 6/7 2. 2.5" SSD module 3. Windows 10 IoT Enterprise 4. Windows 11 IoT GAC (64bit) 5. 7" 800*480 LCD 6. 7" PCAP touch 7. Equipotential terminal pin |
| Customizations | NA |

Order Information

| Item | Cooling | Description |
|-------------|-----------|--|
| WPC-789-PSI | Smart Fan | Core i7-12700E 4.8Ghz, DDR4 16G RAM, M.2 256G SSD / Vpro |
| WPC-789-PSI | Smart Fan | Core i5-12500E 4.5Ghz, DDR4 16G RAM, M.2 256G SSD / Vpro |
| WPC-789-PSI | Smart Fan | Core i9-12900E 5.0Ghz, DDR4 16G RAM, M.2 256G SSD / Vpro |

Rear I.O.



- 1 WIFI Antenna
- 2 Equipotential terminal pin
- 3 3 x RJ-45
- 4 2 x RS232/RS422/RS485
- 5 Line-in/out
- 6 Power
- 7 5 x USB 3.2 Gen2, 1 x Type C
- 8 HDMI
- 9 DP
- 10 VGA
- 11 Mic-in
- 12 4 x PCIe

